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**IN THE UNITED STATES PATENT AND TRADEMARK OFFICE**

Inventor: Hirokazu HONDA

Confirmation No.: 4217

Serial No.: 10/761,510

Filed: January 21, 2004

Title: **FLIP-CHIP TYPE SEMICONDUCTOR DEVICE AND  
METHOD OF MANUFACTURING THE SAME**

Examiner: Thao P. Le

Group Art Unit: 2818

Attorney Docket No.: NECF 18.363A (100806-00248)

October 25, 2005

Mail Stop Amendment  
Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

**AMENDMENT**

S I R:

In response to the non-final Office Action dated May 25, 2005, please amend the subject application as follows: